

SystemPower[™]

TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

General Description

The AAT2822-AAT2825 family of integrated panel power solutions provides the regulated voltages required by an active-matrix thin-film transistor (TFT) liquid-crystal display (LCD). The AAT2822 includes a triple-output DC-DC converter, a LED backlight driver, and a VCOM buffer in a 4 mm x 4mm TQFN package. The primary 1.3MHz DC-DC boost converter uses an ultra-small inductor and ceramic capacitor to generate output voltage (V_{AVDD}) of up to 14.5V for the charge pumps. The low on-resistance of the integrated power MOSFET allows for efficiency up to 93%.

The two charge pumps independently regulate a positive output (VGH) and a negative output (VGL). These low-power outputs use external diode and capacitor stages to regulate output voltages up to +30V and down to -30V. A proprietary regulation algorithm minimizes output ripple when using small capacitors.

The high efficiency backlight driver provides a constant current output capable of boosting up to 28V. The driver is an ideal power solution for backlight applications with up to seven white LEDs in series or up to 39 white LEDs in a parallel and series configuration. LED brightness is PWM controlled up to 1kHz. Filtered PWM is supported for higher frequencies.

The high slew rate operational amplifier is suitable for VCOM buffering and gain adjustment.

The sequencing of the power supplies ensures proper panel startup and avoid damage to the device.

The AAT2822 family is available in a Pb-free, 24-pin 4 x 4mm TQFN package and operates over the -40°C to $+85^{\circ}$ C temperature range.

Features

LCD Bias Power

- 2.5V to 5.5V Input Supply Range
- 1.3MHz Fixed Frequency Current-Mode Step-Up Regulator
- Fast Transient Response
- Adjustable Voltage up to 14.5V
 - ±1% Typical Accuracy
- High Efficiency (93%) @ 50mA Output Current
- Small External Inductor and Capacitors
- Integrated Soft Start and Sequencing of All Rails
- Short-Circuit, Over-Voltage, and Over-Temperature Protection

Positive Output, VGH

- Up to 13.2V Input Supply (V_{DD})
- Adjustable Voltage up to 30V @ 20mA
 - ±3% Typical Accuracy

Negative Output, VGL

- Up to 13.2V Input Supply (V_{DD})
- Adjustable Voltage down to -30V @ 20mA
 - ± 3% Typical Accuracy

WLED Driver

- Input Voltage Range: 2.5V to 25V
- Maximum Continuous Output:
 - 12V @ 260mA
 - 28V @ 50mA
- Panel sizes from 5" 10"
 - 5.0" 3S5P
 - 5.6" 3S6P
 - 7.0" 3S9P
 - 8.0" 3S10P/11P
 - 10" 3S13P
- Constant LED Current with 6% Accuracy
- PWM Dimming Control
 - Up to 1kHz
- 1.3MHz Switching Fixed Frequency
 - Up to 90% Efficiency

VCOM Buffer

- High-Performance
 - 13V/µs Slew Rate
 - 12MHz, -3dB Bandwidth
- ±75mA Output Short-Circuit Current
- Low 1.5mA Quiescent Current

Applications

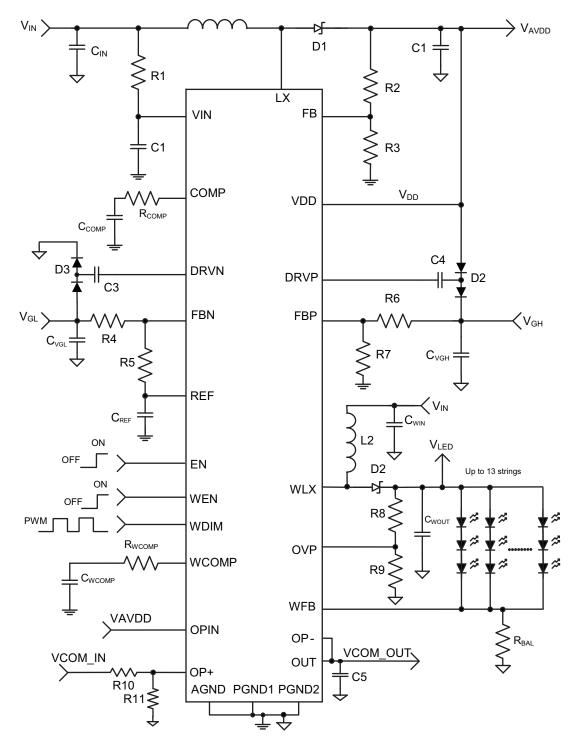
- Automotive Displays
- Digital Photo Frames
- Netbooks
- PNDs



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TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

Typical Application





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Pin Descriptions

Pinout is preliminary and subject to change during development.

	Pin	Number				
AAT2822	AAT2823	AAT28241	AAT28251	Symbol	Function	Description
1	1	n/a	n/a	WLX	0	Boost inductor node. Connect an inductor between IN and WLX. WLX is high impedance in shutdown.
2	2	2	2	PGND2	I/O	Power ground. Connect to GND underneath the IC.
3	3	3	3	REF	0	Internal reference bypass terminal. Connect a 0.1μ F capacitor from this terminal to analog ground (GND). External load capability to 50μ A.
4	4	4	4	FBN	I	Negative charge-pump regulator feedback input. Regulates to 0V nominal.
5	5	n/a	n/a	WEN	I	Active high logic level enable for WLED Driver.
6	6	6	6	DRVN	0	Negative charge-pump driver output. Output high level is VDD, and low level is PGND.
7	7	7	7	VDD	PI	Positive and negative charge-pump driver supply voltage. By- pass to PGND with a $0.1\mu F$ capacitor.
8	8	8	8	DRVP	0	Positive charge-pump driver output. Output high level is VINP, and low level is PGND.
9	9	9	9	EN	I	Active high logic level enable input. Connect EN to IN for normal operation.
10	10	10	10	FBP	I	Positive charge-pump regulator feedback input. Regulates to 0.6V nominal. Connect feedback resistive divider to analog ground (GND).
11	11	11	11	PGND1	I/O	Power ground. Connect to GND underneath the IC.
12	12	12	12	LX	0	Main boost regulator power MOSFET N-channel drain. Connect output diode and output capacitor as close to PGND as possible.
13	13	13	13	COMP	I	Step-up regulator error-amplifier compensation point. Connect a series RC from COMP to AGND.
14	14	14	14	FB	0	Main boost regulator feedback input. Regulates to 0.6V nomi- nal. Connect feedback resistive divider to analog ground (GND) to set output voltage.
15	n/a	15	n/a	OPIN	I	Operational-amplifier power input. Power supply rail for the operational amplifiers. Typically connected to VAVDD. Bypass OPIN to GND with a 0.1μ F capacitor.
16	n/a	16	n/a	OP+	I	Operational-amplifier non-inverting input.
17	n/a	17	n/a	OP-	I	Operational-amplifier inverting input.
18	n/a	18	n/a	OUT	0	Operational-amplifier output.
19	19	n/a	n/a	WCOMP	I	White LED driver error-amplifier compensation point. Connect a series RC from WCOMP to AGND.
20	20	n/a	n/a	WFB	0	Feedback pin. Connect a resistor to ground to set the maximum LED current.
21	21	n/a	n/a	OVP	0	Feedback pin for over-voltage protection sense. Connect a re- sistive divider between the boost converter output and ground.
22	22	22	22	VIN	I	Supply input. +2.5V to +5.5V input range. Bypass with a 0.1μ F capacitor between IN and GND, as close to the pins as possible.
23	23	AGND	AGND	AGND	I/O	Analog ground. Connect to power ground (PGND) underneath the IC.
24	24	n/a	n/a	WDIM	I	Dimming control input. Apply a PWM signal up to 1kHz to adjust the WLED brightness from 100% to 5%, proportional to the duty cycle of the PWM signal.
n/a	15, 16, 17, 18	1, 19, 20, 21	1, 15, 16, 17, 18, 19, 20, 21	N/C		Not connected.
EP	EP	5, 24, EP	5, 24, EP	GND		Ground. EP = Exposed paddle, connect to PCB ground plane.

1. Future products. Please contact factory for availability.



AT2822/23/24/2

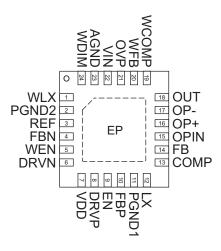
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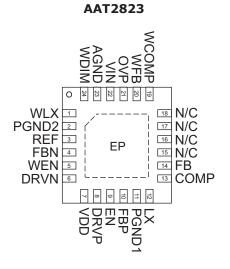
TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

Pin Configurations

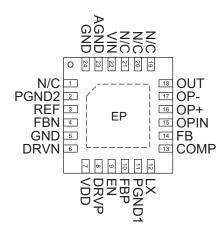


AAT2822

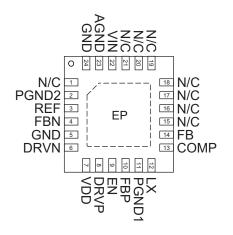




AAT2824



AAT2825







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TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

Part Number Descriptions

Part Number	LCD Bias	Startup Sequence	Backlight	VCOM Buffer
AAT2822	✓	VAVDD->VGH->VGL	\checkmark	✓
AAT2822-1	√	VAVDD->VGL->VGH	√	✓
AAT2823	✓	VAVDD->VGH->VGL	\checkmark	
AAT2823-1	✓	VAVDD->VGL->VGH	\checkmark	
AAT2824	✓	VAVDD->VGH->VGL		✓
AAT2824-1	✓	VAVDD->VGL->VGH		✓
AAT2825	✓	VAVDD->VGH->VGL		
AAT2825-1	✓	VAVDD->VGL->VGH		

Absolute Maximum Ratings¹

 $T_A = 25^{\circ}C$ unless otherwise noted.

Description	Value	Units
V _{IN} , EN	-0.3 to 7	
V _{DD} , OPIN, OUT, OP+, OP-	-0.3 to 15	
LX, WLX	-0.3 to 30	N/
WCOMP, COMP, FB, FBP, FBN, REF, WEN, PWM, WFB, OVP	-0.3 to V _{IN} +0.3	v
DRVP	-0.3 to (V _{DD} +0.3)	
DRVN	-0.3 to (V _{DD} +0.3)	

Thermal Information²

Symbol	mbol Description		Units
Θ_{JA}	Thermal Resistance ³	50	°C/W
P _D	Maximum Power Dissipation	2	W
T	Operating Junction Temperature Range	-40 to 150	°C
T _{LEAD}	Maximum Soldering Temperature (at Leads)	300	

1. Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. Functional operation at conditions other than the operating conditions specified is not implied. Only one Absolute Maximum Rating should be applied at any one time.

2. Mounted on an FR4 board.

3. Derate 20mW/°C above 25°C.



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TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

Electrical Characteristics

 V_{IN} = 5V, EN = WEN = WDIM = V_{IN} , V_{AVDD} = V_{DD} = 12V, T_A = -40°C to 85°C unless otherwise noted. Typical values are at T_A = 25°C.

Symbol	Description	Conditions	Min	Тур	Max	Units
Power Su	pply					
V _{IN}	Input Voltage Range		2.5		5.5	V
V _{UVLO}	Under-Voltage Lockout Threshold	Rising Edge		2.4	2.5	V
UVLO _{HYS}	UVLO Hysteresis			50		mV
I _{IN}	IN Quiescent Current	$V_{FB} = V_{FBP} = 0.7V$, $V_{FBN} = -0.1$, LX not switching		1.1	1.6	mA
I _{SHDN}	Shutdown Current	$EN = WEN = Low, I_{SHDN} = I_{IN} + I_{DD}, V_{DD} = 5V$			1	μA
	REF Output Voltage	No load	1.182	1.20	1.218	V
V_{REF}	REF Load Regulation	$0 < I_{LOAD} < 50 \mu A$			10	mV
	REF Current	In regulation	50			μA
-		Temperature rising		+140		
T_{SD}	Thermal Shutdown	Hysteresis		15		°C
Main Step	-Up Regulator		1			
			V _{IN} -		14 5	V
V _{AVDD}	Output Voltage Range		V _{DIODE}		14.5	V
Fosc	Operating Frequency		910	1300	1690	kHz
DCMAX	Maximum Duty Cycle		86	90		%
V _{FB}	FB Regulation Voltage	No Load	0.588	0.6	0.612	V
	FB Fault Trip Level	V _{FB} falling	0.535	0.546	0.557	V
	FB Load Regulation	$0 < I_{AVDD} < full load$		0.01		%/mA
	FB Line Regulation	$V_{IN} = 2.5V$ to 5.5V		0.1	±0.4	%/V
	FB Input Bias Current	$V_{FB} = 0.7V$	-1		+1	μA
R _{LX(ON)}	LX On-Resistance	I _{LX} = 200mA		350	700	mΩ
I _{IX}	LX Leakage Current	$V_{1x} = 13.2V$		0.01	20	μA
ILIM	LX Current Limit	$V_{FB} = 0.7V$, duty cycle = 75%	1			A
t _{ss}	Soft-Start Period			1.3		ms
Gate High	Charge Pump (VGH)	·				
V _{DD}	V _{DD} Input Supply Range		2.7		13.2	V
00	Operating Frequency			Fosc		kHz
V _{FBP}	FBP Regulation Voltage		0.588	0.6	0.612	V
101	FBP Fault Trip Level	V _{FBP} Falling	470		530	mV
I_{FBP}	FBP Input Bias Current	$V_{\text{FBP}} = 0.7 V$	-1		+1	μA
DRVPP _{RDS}	DRVP PCH ON-Resistance			3	6	Ω
		$V_{FBP} = 0.585V$		1.5	3	Ω
$DRVPN_{RDS}$	DRVP NCH On-Resistance	$V_{\text{FBP}} = 0.615 \text{V}$	20			kΩ
Gate Low	Charge Pump (VGL)		1	1		
V _{DD}	V _{DD} Input Supply Range		2.7		13.2	V
	Operating Frequency			Fosc		Hz
V _{FBN}	FBN Regulation Voltage		-50	0	+50	mV
	FBN Fault Trip Level	V _{FBN} Rising	408	425	442	mV
I_{FBN}	FBN Input Bias Current	$V_{\text{FBN}} = -0.1V$	-1	_	+1	μA
	DRVN PCH ON-Resistance			3	6	Ω
		$V_{FBN} = 0.035V$		1.5	3	Ω
$DRVNN_{RDS}$	DRVN NCH On-Resistance	$V_{\text{FBN}} = -0.025 \text{V}$	20		-	kΩ



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Symbol	Description	Conditions		Min	Тур	Max	Units
WLED Driv	ver (AAT2822, AAT2823 Only)						
V_{LED}	Output Voltage			V _{IN} - V _{DIODE}		28	V
I _{OUT}	Maximum Continuous Output Current	$V_{LED} = 28V$			50		mA
≥V _{FB} / ≥V _{IN}	Line Regulation	$V_{IN} = 2.5V$ to $5.5V$			0.7		%/V
R _{DS(ON)}	Low Side Switch On-Resistance				300		mΩ
V _{WFB}	WFB Pin Regulation			0.282	0.3	0.318	V
T _{ss}	Soft-Start Time	From Enable to Output Re $V_{FB} = 300 \text{mV}$	egulation;		300		μs
V _{OVP}	Over-Voltage Protection Threshold	V _{LED} Rising		0.55	0.60	0.65	V
OV _{HYS}	Over-Voltage Hysteresis	V _{LED} Falling			25		mV
ILIMIT	N-Channel Current Limit			1.3			A
F _{PWM}	Maximum W _{DIM} PWM Frequency					1	kHz
DC _{MIN}	Minimum Duty Cycle			5			%
VCOM Buff	fer (AAT2822 , AAT2824 Only)						
V _{OPIN}	Supply Range			4.5		13.2	V
I _{OPIN}	Supply Current				1.5	2.5	mA
Vos	Input Offset Voltage	$(V_{\text{NEG}}, V_{\text{POS}}, V_{\text{OUT}}) \equiv V_{\text{SUP}}/2$				12	mV
V _{CM}	Input Common-Mode Range			0		V _{SUP}	V
V _{он}	Output Voltage Swing, High	$I_{OUT} = 5mA$		V _{SUP} - 150			mV
V _{OL}	Output Voltage Swing, Low	$I_{OUT} = -5mA$				150	mV
т	Short-Circuit Current	N/ /2	Source	75			
I _{SC}	Short-Circuit Current	V _{SUP} /2	Sink	75			mA
GBW	Gain Bandwidth Product				12		MHz
SR	SR Slew Rate			13		V/µs	
Logic							
WDIM/ WEN∟/EN∟	Enable Input Low Voltage	V _{IN} = 2.5V				0.4	V
WDIM/ WEN _H /EN _H	Enable Input High Voltage	V _{IN} = 5.5V		1.4			V
I _{EN}	WDIM/WEN/EN Input Current					1	μA



AAT2822/23/24/25

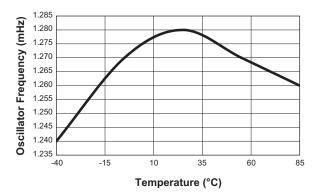
Power Up Sequencing $(VAVDD \rightarrow VGH \rightarrow VGL; V_{IN} = 5.0V)$

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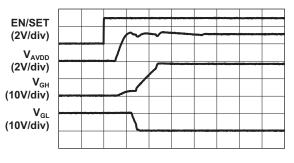
TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

Typical Characteristics

Oscillator Frequency vs. Temperature



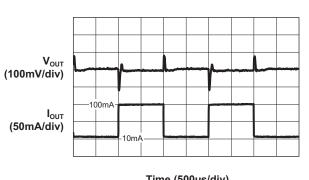
Power Up Sequencing $(VAVDD->VGL->VGH; V_{IN} = 5.0V)$



Time (1ms/div)

Main Boost Load Transient

 $(V_{IN} = 5.0V)$



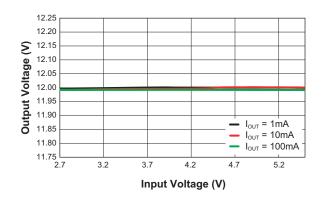
Time (500µs/div)

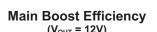
EN/SET (5V/div) \mathbf{V}_{avdd} (5V/div) V_{GH} (20V/div) V_{GL} (20V/div)

Time (500µs/div)

(V_{OUT} = 12V) 100 90 80 70 Efficiency (%) 60 50 40 30 20 10 0 0 50 100 150 200 250 300 350 400 450 500 **Output Current (A)**

Line Regulation





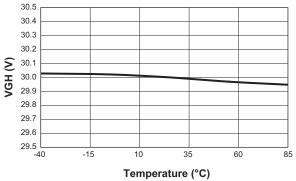


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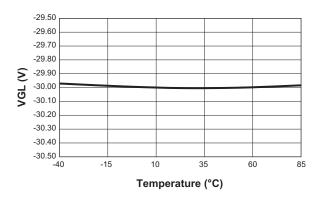
TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

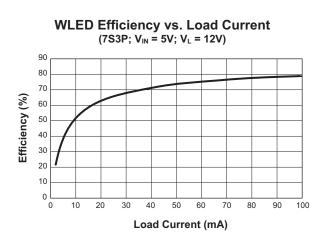
Typical Characteristics

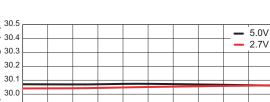
VGH vs. Temperature



VGL vs. Temperature







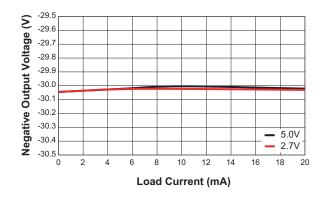
VGH Load Regulation

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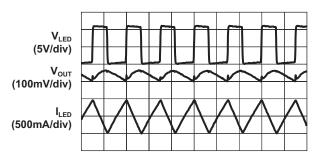
Lossitive Output Voltage (V) 20.00 **Content Voltage** (V) 29.5 0 2 4 6 8 10 12 14 16 18 20

Load Current (mA)

VGL Load Regulation



WLED Operation at 300mA Load $(V_{IN} = 5.0V, 3S13P)$



Time (200µs/div)

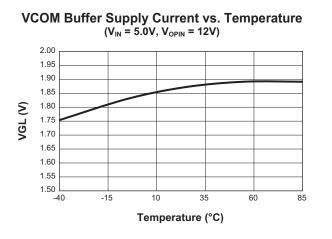


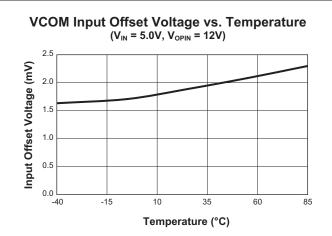
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Typical Characteristics



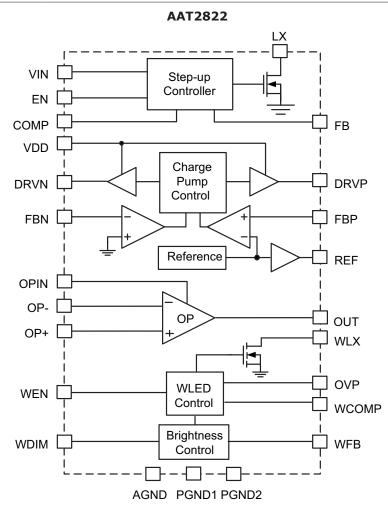




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Functional Block Diagram



Functional Description

Main Boost Converter

The main boost regulator contains a current-mode, fixed-frequency PWM architecture to maximize loop bandwidth and provide fast transient response to pulsed loads typical of TFT-LCD panel source drivers. The 1.3MHz switching frequency allows the use of low profile, low value inductors and ceramic capacitors to minimize the thickness of LCD panel designs.

Dual Charge-Pump Regulator

The AAT2822 provides low-power regulated output voltages from two individual charge pumps to provide the VGH and VGL supplies. Using a single stage, the VGL charge pump inverts the supply voltage (V_{DD}) and pro-

vides a regulated negative output voltage. The VGH charge pump doubles V_{DD} and provides a regulated positive output voltage. These outputs use external Schottky diodes and capacitor multiplier stages (dependent upon the required output voltage) to regulate up to ±30V. Integrated soft-start circuitry minimizes the start-up inrush current and eliminates output voltage overshoot across the full input voltage range and all load conditions. A constant switching frequency of 1.3MHz minimizes output ripple and capacitor size.

White LED Backlight Applications

The AAT2822 consists of a 1.3MHz fixed-frequency DC/ DC boost controller, and an integrated high voltage MOSFET power switch. A high-voltage rectifier, power inductor, output capacitor, and sense resistors are required to implement a DC/DC constant current boost



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converter. Integrated soft-start circuitry minimizes the start-up inrush current and eliminates output voltage overshoot across the full input voltage range and all load conditions. The backlight current is set by an external ballast resistor up to a maximum of 260mA at 12V or 50mA at 28V output. Brightness control is via PWM dimming at up to 1kHz. Higher frequencies are achieved by filtered PWM. The AAT2822 can drive from 3 LEDs in series up to a maximum of 7 LEDs, making it suitable for screen sizes from 5" up to 10". Depending upon the number of LEDs required, up to 9 parallel strings can be successfully driven.

If the OVP input voltage is exceeded the WLED driver continues to regulate at the OVP threshold.

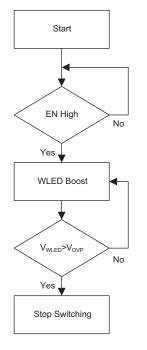


Figure 1: WLED Driver Operation.

VCOM Buffer: Operational Amplifier

The operational amplifier drives the LCD backplane VCOM. The operational amplifier features +/- 75mA(min) output short-circuit current, $13V/\mu s$ slew rate, and 12MHz bandwidth. Internal short-circuit protection limits the short circuit current while the output is directly shorted.

AAT2822/23/24/25

Power Supply Sequencing

The AAT2822 family has integrated power supply sequencing to prevent damage to the LCD screen. Two sequences are available to swap the startup of the positive and negative gate drive voltages. The startup sequence for the "-1" option establishes main boost supply (V_{AVDD}) first, followed by the gate voltages VGL then VGH. The sequence for the plain option is to establish V_{AVDD} first followed by VGH then VGL. The WLED backlight driver is independently controlled by WEN and WDIM.

Operating Faults

The AAT2822 family continuously monitors for fault conditions on the main boost converter and charge pumps according to defined fault trip levels. During operation if any fault conditions persist the controller will shut down all supplies. After removing the fault conditions, recycle the enables to start up the supplies.



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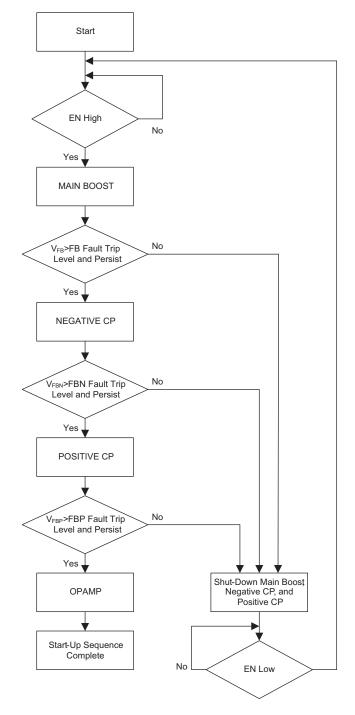


Figure 2: Startup Sequence for AAT282X-1¹.

Application Information

Main Step-Up Converter

Output Capacitor

The high output ripple inherent in the boost converter necessitates low impedance output filtering. Multi-layer ceramic (MLC) capacitors provide small size and adequate capacitance, low parasitic equivalent series resistance (ESR) and equivalent series inductance (ESL), and are well suited for use with the primary step-up converter. MLCs of type X7R or X5R are recommended to ensure good capacitance stability over the full operating temperature range.

The output capacitor is sized to maintain the output load without significant voltage droop during the power switch ON interval, when the output diode is not conducting. A ceramic output capacitor with a minimum value of 2.2μ F is recommended. Typically, 25V rated ceramic capacitors are required for the 24V boost output. Ceramic capacitors sized as small as 0805 are available which meet these requirements. MLCs exhibit significant capacitance reduction with applied voltage. Output ripple measurements should confirm that output voltage droop is acceptable.

Input Capacitor

The boost converter input current flows during both ON and OFF switching intervals. The input ripple current is less than the output ripple and, as a result, less input capacitance is required. However, the AAT2822 input voltage is shared among other channels; a ceramic input capacitor from 4.7μ F to 10μ F is recommended. Minimum 6.3V rated ceramic capacitors are required at the input. Ceramic capacitors sized as small as 0603 are available which meet these requirements.

Large capacitance tantalum or solid-electrolytic capacitors may be necessary to meet stringent output ripple and transient load requirements. These can replace (or be used in parallel with) ceramic capacitors. Both tantalum and OSCON-type capacitors are suitable due to their low ESR and excellent temperature stability (although they exhibit much higher ESR than MLCs). Aluminumelectrolytic types are less suitable due to their high ESR characteristics and temperature drift. Unlike MLCs, these types are polarized and proper orientation on input and output pins is required. 30% to 70% voltage derating is recommended for tantalum capacitors.

1. For AAT282x the startup sequence is positive charge pump followed by the negative charge pump.





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TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

Selecting the Schottky Diode

To ensure minimum forward voltage drop and no recovery, high voltage Schottky diodes are the best choice for the primary step-up converter. The output diode is sized to maintain acceptable efficiency and reasonable operating junction temperature under full load operating conditions. Forward voltage (V_F) and package thermal resistance (θ_{JA}) are the dominant factors to consider in selecting a diode. The diode's published current rating may not reflect actual operating conditions and should be used only as a comparative measure between similarly rated devices. 20V rated Schottky diodes are recommended for outputs less than 15V, while 30V rated Schottky diodes are recommended for outputs greater than 15V.

The average diode current is equal to the output current:

$$I_{AVG} < I_{OUT}$$

The average output current multiplied by the forward diode voltage determines the loss of the output diode.

$$P_{\text{LOSS DIODE}} = I_{\text{AVG}} \cdot V_{\text{F}} = I_{\text{OUT}} \cdot V_{\text{F}}$$

Diode junction temperature can be estimated:

$$T_{J} = T_{A} + \theta_{JA} \cdot P_{LOSS_DIODE}$$

The junction temperature should be maintained below 110°C, but may vary depending on application and/or system guidelines. The diode θ_{JA} can be minimized with additional PCB area on the cathode. PCB heat sinking the anode may degrade EMI performance.

The reverse leakage current of the rectifier must be considered to maintain low quiescent (input) current and high efficiency under light load. The rectifier's reversed current increases dramatically at high temperatures.

Selecting the Main Step-Up Inductor

The primary step-up converter is designed to operate with a 2.2µH inductor for all input and output voltage combinations. The inductor saturation current rating should be greater than the NMOS current limit. If necessary, the peak inductor current can exceed the saturation level by a small amount with no significant effect on performance. The maximum duty cycle can be estimated from the relationship for a continuous mode boost converter. Maximum duty cycle (D_{MAX}) is the duty cycle at minimum input voltage ($V_{IN(MIN)}$).

$$\mathsf{D}_{\mathsf{MAX}} = \frac{(\mathsf{V}_{\mathsf{OUT}} + \mathsf{V}_{\mathsf{F}} - \mathsf{V}_{\mathsf{IN}(\mathsf{MIN})})}{\mathsf{V}_{\mathsf{OUT}} + \mathsf{V}_{\mathsf{F}}}$$

Where $V_{\rm F}$ is the Schottky diode forward voltage and can be estimated at 0.5V. Manufacturer's specifications list both the inductor DC current rating, which is a thermal limitation, and peak inductor current rating, which is determined by the saturation characteristics. Measurements at full load and high ambient temperature should be completed to ensure that the inductor does not saturate or exhibit excessive temperature rise.

The output inductor (L) is selected to avoid saturation at minimum input voltage, maximum output load conditions. Peak current may be calculated from the following equation, again assuming continuous conduction mode. Worst-case peak current occurs at minimum input voltage (maximum duty cycle) and maximum load. Switching frequency (F_s) is at 1.3MHz with a 2.2µH inductor.

$$I_{PEAK} = \frac{I_{OUT}}{1 - D_{MAX}} + \frac{D_{MAX} \cdot V_{IN(MIN)}}{2 \cdot F_{S} \cdot L}$$

The RMS current flowing through the boost inductor is equal to the DC plus AC ripple components.

Under worst-case RMS conditions, the current waveform is critically continuous. The resulting RMS calculation yields worst-case inductor loss. The RMS value should be compared against the manufacturer's temperature rise or thermal derating guidelines.

$$I_{\text{RMS}} = \frac{I_{\text{PEAK}}}{\sqrt{3}}$$

For a given inductor type, smaller inductor size leads to an increase in DCR winding resistance and, in most cases, increased thermal impedance. Winding resistance degrades boost converter efficiency and increases the inductor operating temperature.

$$P_{LOSS_INDUCTOR} = I_{RMS}^2 \cdot DCR$$

Setting the Output Voltage

The resistive divider network R2 and R3 of Figure 7 programs the output to regulate at a voltage higher than 0.6V as shown in Table 1. To limit the bias current required for the external feedback resistor string while maintaining good noise immunity, the minimum suggested value for R3 is $6.04k\Omega$. The resistive divider can be calculated in the following equation:

$$\mathsf{R}_3 = \mathsf{R}_2 \cdot \left(\frac{\mathsf{V}_{\mathsf{AVDD}}}{\mathsf{V}_{\mathsf{REF}}} \cdot 1\right) = \mathsf{R}_2 \cdot \left(\frac{\mathsf{V}_{\mathsf{AVDD}}}{0.6\mathsf{V}} \cdot 1\right)$$





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V _{AVDD} (V)	R ₃ = 6.04kΩ R ₂ (kΩ)	R ₃ = 59kΩ R ₂ (MΩ)
9	84.5	0.825
10	93.1	0.931
11	105	1.02
12	115	1.13
13	124	1.21
15	143	1.4
20	196	1.1
22	215	2.1
24	237	2.3

Table 1: Setting the Output Voltage for the Main Step-Up Converter.

Selecting Compensation Components

The AAT2822 main boost architecture uses peak current mode control to eliminate the double pole effect of the output L&C filter and simplifies compensation loop design. The current mode control architecture simplifies the transfer function of the control loop to a one-pole, one left plane zero and one right half plane (RHP) system in frequency domain. The dominant pole can be calculated by:

$$f_{\rm P} = \frac{1}{2\pi \cdot R_{\rm O} \cdot C_{\rm 6}}$$

The ESR zero of the output capacitor can be calculated by:

 $f_{Z_ESR} = \frac{1}{2\pi \cdot R_{ESR} \cdot C_6}$

Where:

C₆ is the output filter capacitor

R_o is the load resistor value

 $R_{\mbox{\tiny ESR}}$ is the equivalent series resistance of the output capacitor.

The right half plane (RHP) zero can be determined by:

$$f_{Z_RHP} = \frac{V_{IN}^2}{2\pi \cdot L_1 \cdot I_{AVDD} \cdot V_{AVDD}}$$

It is recommended to design the bandwidth to one decade lower than the frequency of RHP zero to guarantee the loop stability. A series capacitor and resistor network (R11 and C8) connected to the COMP pin sets the pole and zero which are given by:

$$f_{P_COM} = \frac{1}{2\pi \cdot R_{EA} \cdot C_8}$$

$$f_{Z_COM} = \frac{1}{2\pi \cdot R_{11} \cdot C_8}$$

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Where:

 C_8 is the compensation capacitor

R₁₁ is the compensation resistor

 R_{EA} is the output resistance of the error amplifier (M Ω).

A 100pF capacitor and a 200k Ω resistor in series are chosen for optimum phase margin and fast transient response.

Charge Pump

The number of charge pump stages required for a given output (V_{GH}) varies with the input voltage applied (V_{AVDD}) from the main boost. A lower input voltage requires more stages for a given output. If the numbers of stages increases, the maximum load current limitation of the charge pump would be decreased to maintain output voltage regulation.

The number of stages required can be estimated by:

$$n_{P} = \frac{V_{GH} - V_{AVDD(MIN)}}{V_{AVDD(MIN)} - 2V_{F}}$$

for the positive output and

$$n_{\rm N} = \frac{V_{\rm GL}}{2V_{\rm F} - V_{\rm AVDD(MIN)}}$$

for the negative output where $V_{\rm F}$ = 0.31V is the forward voltage of the BAT54 Schottky diode at 4mA forward current.

When solving for n_p and n_n , round up the solution to the next highest integer to determine the number of stages required.

Negative Output Voltage (V_{GL})

The negative output voltage is adjusted by a resistive divider from the output (V_{ON}) to the FBN and REF pins. The maximum reference voltage current is 200µA; therefore, the minimum allowable value for R_{10} of Figure 6 is 6.04k Ω . It is best to select the smallest value possible for R_{10} , as this will keep the value of R_9 to a minimum. With R_{10} selected, R_9 can be determined:

$$\mathsf{R}_{9} = \frac{\mathsf{V}_{\mathsf{GL}}}{\mathsf{V}_{\mathsf{REF}}} \cdot \mathsf{R}_{10} = \frac{\mathsf{V}_{\mathsf{GL}}}{1.2\mathsf{V}} \cdot \mathsf{R}_{10}$$



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Positive Output Voltage (V_{GH})

The positive output voltage is set by a resistive divider from the output (V_{GH}) to the FBP and ground pins. Limiting the value of R_7 to $6.04 k\Omega$ or lower reduces noise in the feedback circuit.

Once R_7 has been determined, solve for R_6 :

$$\mathsf{R}_{6} = \mathsf{R}_{7} \cdot \left(\frac{\mathsf{V}_{\mathsf{GH}}}{\mathsf{V}_{\mathsf{REF}}} - 1\right) = \mathsf{R}_{7} \cdot \left(\frac{\mathsf{V}_{\mathsf{GH}}}{0.6\mathsf{V}} - 1\right)$$

Flying and Output Capacitors

The minimum value for the flying capacitor is limited by the output power requirement, while the maximum value is set by the bandwidth of the power supply. If C_{FLY} is too small, the output may not be able to deliver the power demanded, while too large of a capacitor may limit the bandwidth and time required to recover from load and line transients. A 0.1μ F X7R or X5R ceramic capacitor is typically used. The voltage rating of the flying and reservoir output capacitors varies with the number of charge pump stages. The reservoir output capacitor value should be roughly 10 times the value of the flying capacitor. Use larger capacitors for reduced output ripple.

Input Capacitor

The primary function of the input capacitor is to provide a low impedance loop for the edges of pulsed current drawn by the IC. A low ESL X7R or X5R type ceramic capacitor is ideal for this function. The size required will vary depending on the load, output voltage, and input voltage characteristics. Typically, the input capacitor value should be 5 to 10 times the value of the flying capacitor. If the source impedance of the input supply is high, a larger capacitor may be required. To minimize stray inductance, the capacitor should be placed as closely as possible to the IC. This keeps the high frequency content of the input current localized, minimizing radiated and conducted EMI.

Rectifier Diodes

For the rectifiers, use Schottky diodes with a voltage rating of 1.5 times the input voltage. The maximum steadystate voltage seen by the rectifier diodes for both the positive and negative charge pumps (regardless of the number of stages) is:

$$V_{\text{REVERSE}} = V_{\text{IN}} - V_{\text{F}}$$

The BAT54SDW quad Schottky diode in a SOT363 (2x2mm) package is a good choice for multiple-stage charge pump configuration.

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White LED Driver

The white LED backlight driver can be enabled when input supply rises above under voltage lockout threshold. To reduce inrush current it is recommended that the main boost and white LED driver are not enabled concurrently.

Over-Voltage Protection (OVP) with Open Circuit Failure

The OVP protection circuit consists of a resistor network tied from the output voltage to the OVP pin (see Figure 3). To protect the device from open circuit failure, the resistor divider can be selected such that the over-voltage threshold occurs prior to the output reaching $V_{\text{LED+(MAX)}}$. The value of R_5 should be selected from $10k\Omega$ to $20k\Omega$ to minimize losses without degrading noise immunity.

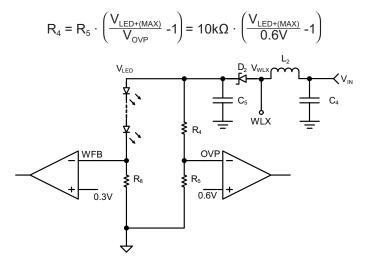


Figure 3: Over-Voltage Protection Circuit.

OVP Constant Voltage Operation

Under closed loop constant current conditions, the output voltage is determined by the operating current, LED forward voltage characteristics (V_{FLED}), quantity of series connected LEDs (N), and the feedback pin voltage (V_{FB}).

$$V_{OUT} = V_{FB} + N \cdot V_{FLED}$$



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When the rising OVP threshold is exceeded, switching is stopped and the output voltage decays. Switching automatically restarts when the output drops below the lower OVP hysteresis voltage (100mV typical), and as a result the output voltage increases. The cycle repeats, maintaining an average DC output voltage proportional to the average of the rising and falling OVP levels (multiplied by the resistor divider scaling factor). High operating frequency and low output voltage ripple ensure DC current and negligible flicker in the LED string(s).

While OVP is active, the maximum LED current programming error (ΔI_{LED}) is proportional to voltage error across an individual LED (ΔV_{FLED}).

$$\Delta V_{FLED} = \frac{N \cdot V_{FLED(TYP)} - V_{OVP(MIN)} - V_{WFB}}{N}$$

To minimize the ΔI_{LED} error, the minimum OVP voltage $(V_{OVP(MIN)})$ may be increased, yielding a corresponding increase in the maximum OVP voltage $(V_{OVP(MAX)})$.

Measurements should confirm that the maximum switching node voltage ($V_{WLX(MAX)}$) is less than 30V under worst case operating conditions.

$$V_{\text{WLX(MAX)}} = V_{\text{OVP(MAX)}} \cdot \left(\frac{R_2}{R_1} + 1\right) + V_{\text{F}} + V_{\text{RING}}$$

 V_F is the Schottky diode D_2 forward voltage at turn-OFF.

 V_{RING} is the voltage ring occurring at turn-OFF.

White LED Selection and Current Setting

The WLED current is controlled by the WFB voltage and the ballast resistor (R_8). For maximum accuracy, a 1% tolerance resistor is recommended.

The ballast resistor $(\mathsf{R}_{\scriptscriptstyle{\$}})$ value can be calculated as follows:

$$\mathsf{R}_8 = \left(\frac{\mathsf{V}_{\mathsf{WFB}(\mathsf{MAX})}}{\mathsf{I}_{\mathsf{LED}(\mathsf{MAX})}}\right)$$

Where $V_{WFB} = 0.3V$

For example, if the maximum current for each string of 3 series LEDs is 20mA, the maximum current for a 10 inch panel (3S13P) is 260mA (20mA x 13), which corresponds to a minimum resistor value of 1.15Ω

$$R_8 = \left(\frac{0.3V}{260mA}\right) = 1.15\Omega$$

Maximum I _{LED} Current (mA)	R₈(Ω)
30	0.768
25	0.909
20	1.15
15	1.54
10	2.32
5	4.64

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Table 2: Maximum LED Current and Ballast Resistor (R₈) Values for 10" Panel Size.

Typical white LEDs are driven at maximum continuous currents of 15mA to 20mA. The maximum number of series-connected LEDs is determined by the minimum output voltage of the boost converter (V_{LED}), minus the maximum feedback voltage ($V_{WFB(MAX)}$) divided by the maximum LED forward voltage ($V_{FLED(MAX)}$) which can be estimated from the manufacturers' datasheet at the maximum LED operating current.

$$V_{\text{LED}} = V_{\text{OVP}(\text{TYP})} \cdot \left(\frac{R_5}{R_4} + 1\right)$$
$$N = \left(\frac{V_{\text{OVP}(\text{MIN})} - V_{\text{WFB}(\text{MAX})}}{V_{\text{FLED}(\text{MAX})}}\right)$$

For example, the typical forward voltage of the white LED is 3.5V at 20mA.

$$V_{\text{LED}} = V_{\text{OVP}(\text{TYP})} \cdot \left(\frac{R_5}{R_4} + 1\right) = 0.6V \cdot \left(\frac{464k\Omega}{10k\Omega} + 1\right) = 27.8V$$
$$N = \left(\frac{V_{\text{OVP}(\text{MIN})} - V_{\text{WFB}(\text{MAX})}}{V_{\text{FLED}(\text{MAX})}}\right) = \left(\frac{27.8V - 0.6V}{3.5V}\right) = 7.8 \text{ LEDs}$$

Therefore, under these typical operating conditions, 7 LEDs can be used in series for each string.

PWM Dimming Control

The dimming of the white LED can be controlled using a PWM or a filter PWM signal. By connecting a PWM signal to the WDIM pin and adjusting the duty cycle of the PWM signal, the dimming of the white LED changes proportionally to the percentage of the duty cycle as shown in Figure 4. However, the dimming control using PWM connected to the WDIM pin can operate at a frequency up to 1KHz.



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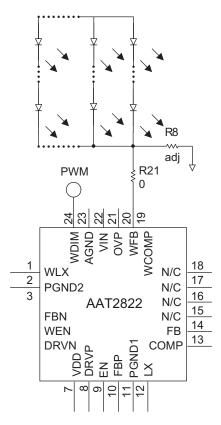


Figure 4: PWM Dimming Control.

For applications requiring a PWM frequency higher than 1KHz, an external filter PWM is connected to the WFB pin to control the dimming of the white LED. This low-pass filter (R_{23}/C_{25}) integrates the high frequency PWM signal to produce a DC dimming control as shown in Figure 5.

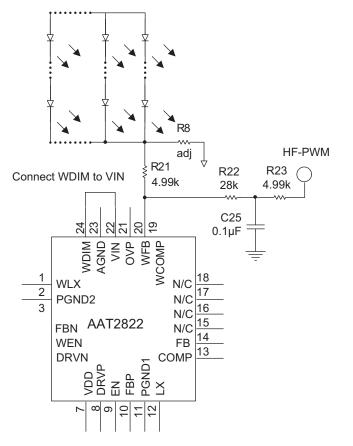


Figure 5: Low-Pass Filter PWM Dimming Control.

When the PWM duty cycle is adjusted, the DC voltage across the ballast resistor (R_8) changes, resulting in change of the white LED current. Apply the KCL at the feedback node (WFB). The voltage across the R_8 resistor can be expressed:

$$V_{R8} = 0.3V - \frac{R_{21}}{R_{22}} \cdot (V_{C25} - 0.3V)$$

For minimum dimming, $V_{R8} = 0V$.



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Choose R_{21} = 4.99k Ω and V_{C25} = 2V, and solve for R_{22} :

$$R_{22} = \frac{R_{21}}{(0.3V - V_{R8}) \cdot (V_{C25} - 0.3V)} = 28k\Omega$$

The low-pass filter should be chosen to produce an acceptable ripple for the DC dimming voltage and a small time constant. For application where the PWM frequency is greater than 10KHz, the optimum values for the low-pass filter are $R_{23} = 4.99 k\Omega$ and $C_{25} = 0.1 \mu F$.

Selecting the Schottky Diode

To ensure minimum forward voltage drop and no recovery, high-voltage Schottky diodes are considered the best choice for the WLED boost converter. The output diode is sized to maintain acceptable efficiency and reasonable operating junction temperature under full load operating conditions. Forward voltage (V_F) and package thermal resistance (θ_{1A}) are the dominant factors to consider in selecting a diode. The diode's non-repetitive peak forward surge current rating (I_{FSM}) should be considered for high pulsed load applications such as camera flash. The I_{ESM} rating drops with increasing conduction period. Manufacturers' datasheets should be consulted to verify reliability under peak load conditions. The diode's published current rating may not reflect actual operating conditions and should be used only as a comparative measure between similarly rated devices.

40V rated Schottky diodes are recommended for outputs less than 30V, while 60V rated Schottky diodes are recommended for outputs greater than 35V.

The average diode current is equal to the output current:

$$\mathbf{I}_{\mathrm{AVG}} = \mathbf{I}_{\mathrm{OUT}}$$

The average output current multiplied by the forward diode voltage determines the loss of the output diode.

$$\mathsf{P}_{\mathsf{LOSS_DIODE}} = \mathsf{I}_{\mathsf{AVG}} \cdot \mathsf{V}_{\mathsf{F}} = \mathsf{I}_{\mathsf{OUT}} \cdot \mathsf{V}_{\mathsf{F}}$$

Diode junction temperature can be estimated:

$$T_{J} = T_{A} + \theta_{JA} \cdot P_{LOSS_DIODE}$$

Output diode junction temperature should be maintained below 110°C, but may vary depending on application and/or system guidelines. The diode θ_{JA} can be minimized with additional PCB area on the cathode. PCB heat-sinking the anode may degrade EMI performance. The reverse leakage current of the rectifier must be considered to maintain low quiescent (input) current and high efficiency under light load. The rectifier's reverse current increases dramatically at elevated temperatures.

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PRODUCT DATASHEET

Selecting the WLED Step-Up Inductor

The WLED step-up converter has the same topology as the main step-up converter. It is designed to operate with a 2.2μ H inductor for all input and output voltage combinations. The inductor saturation current rating should be greater than the NMOS current limit.

$$\mathsf{D}_{\mathsf{MAX}} = \frac{(\mathsf{V}_{\mathsf{OUT}} + \mathsf{V}_{\mathsf{F}} - \mathsf{V}_{\mathsf{IN}(\mathsf{MIN})})}{\mathsf{V}_{\mathsf{OUT}} + \mathsf{V}_{\mathsf{F}}}$$

The output inductor (L) is selected to avoid saturation at minimum input voltage and maximum output load conditions. Peak current may be calculated from the following equation, again assuming continuous conduction mode. Worst-case peak current occurs at minimum input voltage (maximum duty cycle) and maximum load. Switching frequency is estimated at 1.3MHz with a 2.2 μ H inductor.

$$I_{\text{PEAK}} = \frac{I_{\text{OUT}}}{1 - D_{\text{MAX}}} + \frac{D_{\text{MAX}} \cdot V_{\text{IN(MIN)}}}{2 \cdot F_{\text{S}} \cdot L}$$

Selecting the WLED Step-Up Capacitors

The high output ripple inherent in the boost converter necessitates low impedance output filtering.

Multi-layer ceramic (MLC) capacitors provide small size and adequate capacitance, low parasitic equivalent series resistance (ESR) and equivalent series inductance (ESL), and are well suited for use with the WLED boost regulator. MLC capacitors of type X7R or X5R are recommended to ensure good capacitance stability over the full operating temperature range.

The output capacitor is sized to maintain the output load without significant voltage droop (ΔV_{OUT}) during the power switch ON interval, when the output diode is not conducting. A ceramic output capacitor with a value of 2.2µF to 4.7µF is recommended. Typically, 50V rated capacitors are required for the 28V maximum boost output. Ceramic capacitors sized as small as 0805 or 1206 are available which meet these requirements.



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MLC capacitors exhibit significant capacitance reduction with applied voltage. Output ripple measurements should confirm that output voltage droop and operating stability are acceptable. Voltage derating can minimize this factor, but results may vary with package size and among specific manufacturers.

The output capacitor size can be estimated using the equation:

$$C_{OUT} = \frac{I_{OUT} \cdot D_{MAX}}{F_{S} \cdot \Delta V_{OUT}}$$

To maintain stable operation at full load, the output capacitor should be sized to maintain ΔV_{OUT} between 100mV and 200mV.

The WLED boost converter input current flows during both ON and OFF switching intervals. The input ripple current is lower than the output ripple and, as a result, a lower input capacitance is required.

LCD VCOM Buffer

The VCOM buffer is designed to drive the voltage on the backplane of an LCD display. The buffer must be capable of sinking and sourcing capacitive pulse current at low frequency. A 10nF ceramic output capacitor in series with a 100 Ω resistor is sufficient for buffer stability at high frequencies.

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The VCOM output voltage is typically set to half of the main boost output voltage V_{ADD} . The maximum input bias voltage for the VCOM buffer (V_{OPIN}) cannot exceed 13V. In applications where the main boost output voltage V_{VADD} is greater than 13V, V_{OPIN} should be connected to an external supply to prevent damage to the device; the jumper J_7 should be left open to disconnect V_{AVDD} from V_{OPIN} .





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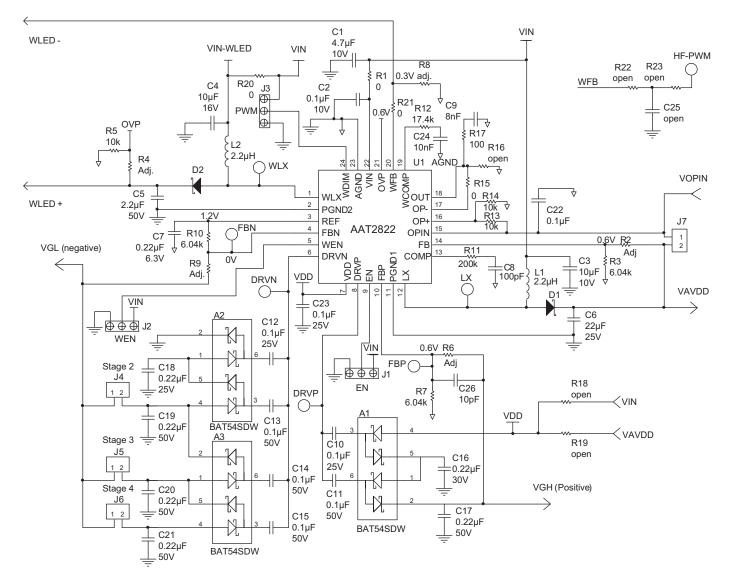


Figure 6: AAT2822IBK Evaluation Board Schematic.



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Symbol	Part Number	Description	Manufacturer
U1	AAT2822IBK	TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer	AnalogicTech
C1		4.7µF/10V/X5R/0603	
C2		0.1µF/16V/10%/X7R/0603	
C3, C4		10µF 10V X7R 0805	
C5		2.2µF 50V X7R 1206	
C6		22µF 16V 1206	
C7		0.22µF 10V 10% X7R 0603	
C8		100pF 25V 10% X7R 0603	
C9		8nF 50V X7R 0805	
C10, C12, C13, C22, C23		0.1µF 25V 10% X7R 0603	
C11, C14, C15		0.1µF 50V 10% X7R 0603	
C16, C17, C18, C19, C20, C21		0.22µF 50V 10% X7R 0805	
C24		10nF 50V 10% X7R 0603	
C26		10pF 25V 0603	
A1, A2, A3	BAT54SDW-7-F	Schottky Diode Array 30V SC70-6	Diodes Inc
D1, D2	MSS1P5-M3/89A	Schottky Diode 1A 50V Micro SMP	Vishay
L1, L2	SD25-2R2R	Inductor 2.2 μ H DCR = 31.1m Ω I _{SAT} = 2.8A	Cooper Bussmann
R2, R4, R6, R8, R9		Adjustable value (see Equations 1-5 and Table 4); 0603	
R15, R19, R20, R21		0Ω 1/10W 1% 0603	
R3, R7, R10		6.04kΩ 1/10W 1% 0603	
R5, R13, R14		10kΩ 1/10W 1% 0603	
R11		200kΩ 1/10W 1% 0603	
R12		17.4kΩ 1/10W 1% 0603	
R17		100Ω 1/10W 1% 0603	
J1, J2, J3, J4, J5, J6	TSW-136-17-L-S	Conn. Header 36 Pos100" SGL Gold	Samtex, Inc.

Table 3: AAT2822IBK Evaluation Board Bill Of Materials (BOM).

Panel Sizes (inches)	WLED Matrix (Series and Parallel)	Ballast Resistor R_8 (Ω)
5	3S5P	2.37
5.6	3S6P	2.0
7	3S9P	1.3
8	3S10P/11P	1.2
10	3S13P	1.0
5	7S2P	4.7

Table 4: Ballast Resistor Selection for Different Panel Sizes.

$$\begin{split} \textbf{Eq. 1:} \ \textbf{R}_{2} &= \textbf{R}_{3} \cdot \left(\frac{\textbf{V}_{\text{AVDD}}}{\textbf{V}_{\text{REF}}} \text{ -1}\right) = 6.04 \text{k}\Omega \cdot \left(\frac{\textbf{V}_{\text{AVDD}}}{0.6 \text{V}} \text{ -1}\right) \\ \textbf{Eq. 2:} \ \textbf{R}_{9} &= \frac{\textbf{V}_{\text{GL}}}{\textbf{V}_{\text{REF}}} \cdot \textbf{R}_{10} = \frac{\textbf{V}_{\text{GL}}}{1.2 \text{V}} \cdot 6.04 \text{k}\Omega \\ \textbf{Eq. 3:} \ \textbf{R}_{6} &= \textbf{R}_{7} \cdot \left(\frac{\textbf{V}_{\text{GH}}}{\textbf{V}_{\text{REF}}} \text{ -1}\right) = 6.04 \text{k}\Omega \cdot \left(\frac{\textbf{V}_{\text{GH}}}{0.6 \text{V}} \text{ -1}\right) \\ \textbf{Eq. 4:} \ \textbf{R}_{4} &= \textbf{R}_{5} \cdot \left(\frac{\textbf{V}_{\text{LED+(MAX)}}}{\textbf{V}_{\text{OVP}}} \text{ -1}\right) = 10 \text{k}\Omega \cdot \left(\frac{\textbf{V}_{\text{LED+(MAX)}}}{0.6 \text{V}} \text{ -1}\right) \\ \textbf{Eq. 5:} \ \textbf{R}_{8} &= \frac{\textbf{V}_{\text{WFB}(\text{MAX)}}}{\textbf{I}_{\text{LED}(\text{MAX)}}} = \frac{0.3 \text{V}}{\textbf{I}_{\text{LED}(\text{MAX)}}} \end{split}$$





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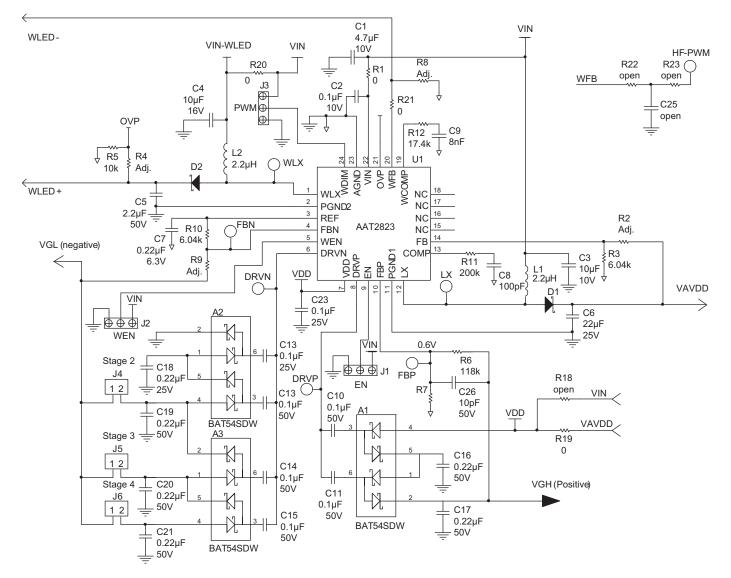


Figure 7: AAT2823IBK Evaluation Board Schematic.





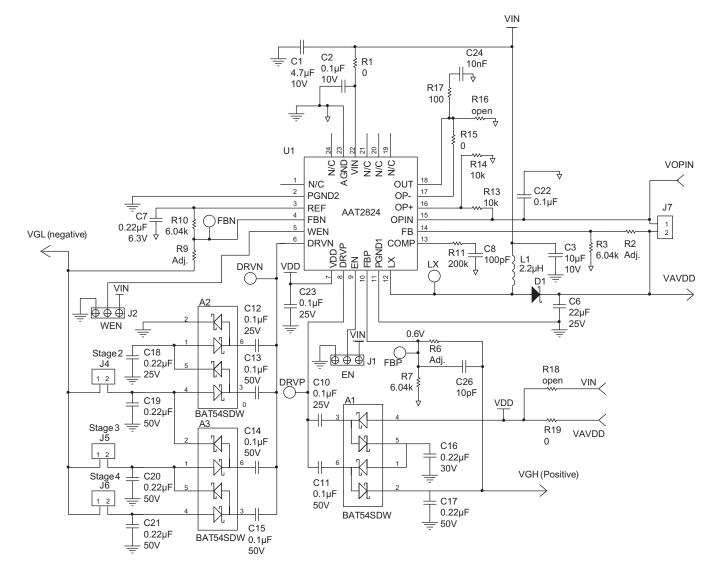


Figure 8: AAT2824IBK Evaluation Board Schematic.





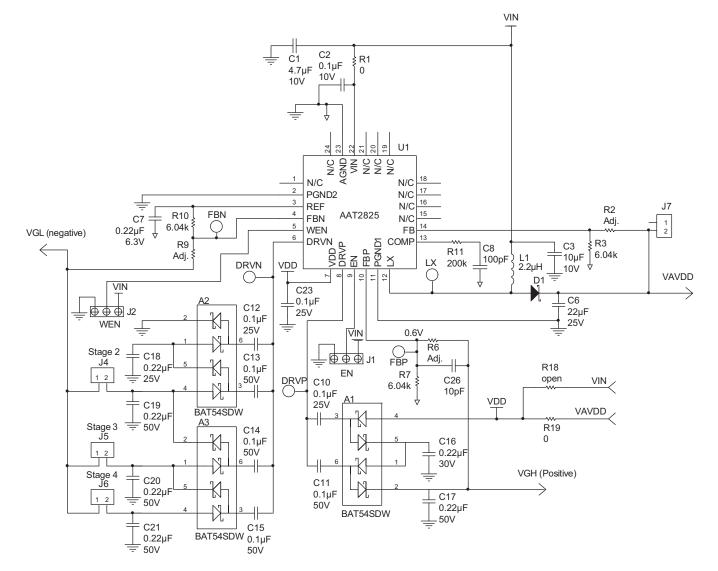


Figure 9: AAT2825IBK Evaluation Board Schematic.



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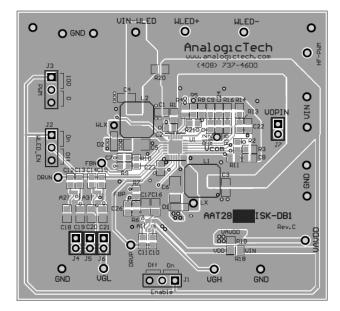
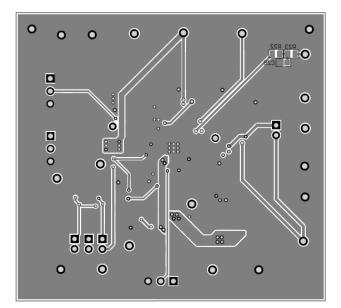


Figure 10: AAT28XXIBK Evaluation Board Top Side Layout.



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Figure 11: AAT28XXIBK Evaluation Board Bottom Side Layout.





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TFT-LCD DC-DC Converter with WLED Driver and VCOM Buffer

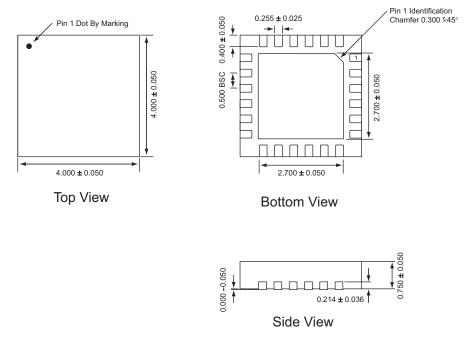
Ordering Information^{1,2}

Package	Part Marking ¹	Part Number (Tape and Reel) ²
TQFN44-24	8XXYY	AAT2822IBK-T1
TQFN44-24	F8XYY	AAT2822IBK-1-T1
TQFN44-24	B7XYY	AAT2823IBK-T1
TQFN44-24	F9XYY	AAT2823IBK-1-T1
TQFN44-24		AAT2824IBK-T1
TQFN44-24		AAT2824IBK-1-T1
TQFN44-24		AAT2825IBK-T1
TQFN44-24		AAT2825IBK-1-T1



All AnalogicTech products are offered in Pb-free packaging. The term "Pb-free" means semiconductor products that are in compliance with current RoHS standards, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. For more information, please visit our website at http://www.analogictech.com/aboutus/quality.php.

Package Information³



TQFN44-24

All dimensions in millimeters.

1. XYY = assembly and date code.

- 2. Sample stock is generally held on part numbers listed in **BOLD**.
- 3. The leadless package family, which includes QFN, TQFN, DFN, TDFN and STDFN, has exposed copper (unplated) at the end of the lead terminals due to the manufacturing process. A solder fillet at the exposed copper edge cannot be guaranteed and is not required to ensure a proper bottom solder connection.



AAT2822/23/24/25

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